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HCS12 Microcontrollers

*Module Mapping
Control (MMC) V4*

S12MMCV4/D
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Revision History

Version Number	Revision Date	Effective Date	Author	Description of Changes
4.00	2/4/2003	2/4/2003	John Langan	Creation of block user guide from core user guide version 1.5 (July 2, 2002). Changes include: updating format and making end customer friendly. Original release.

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Section 1 Introduction to Module Mapping Control (MMC)

This section describes the functionality of the Module Mapping Control (MMC) sub-block of the S12 Core Platform.

The block diagram of the MMC is shown in [Figure 1-1](#).

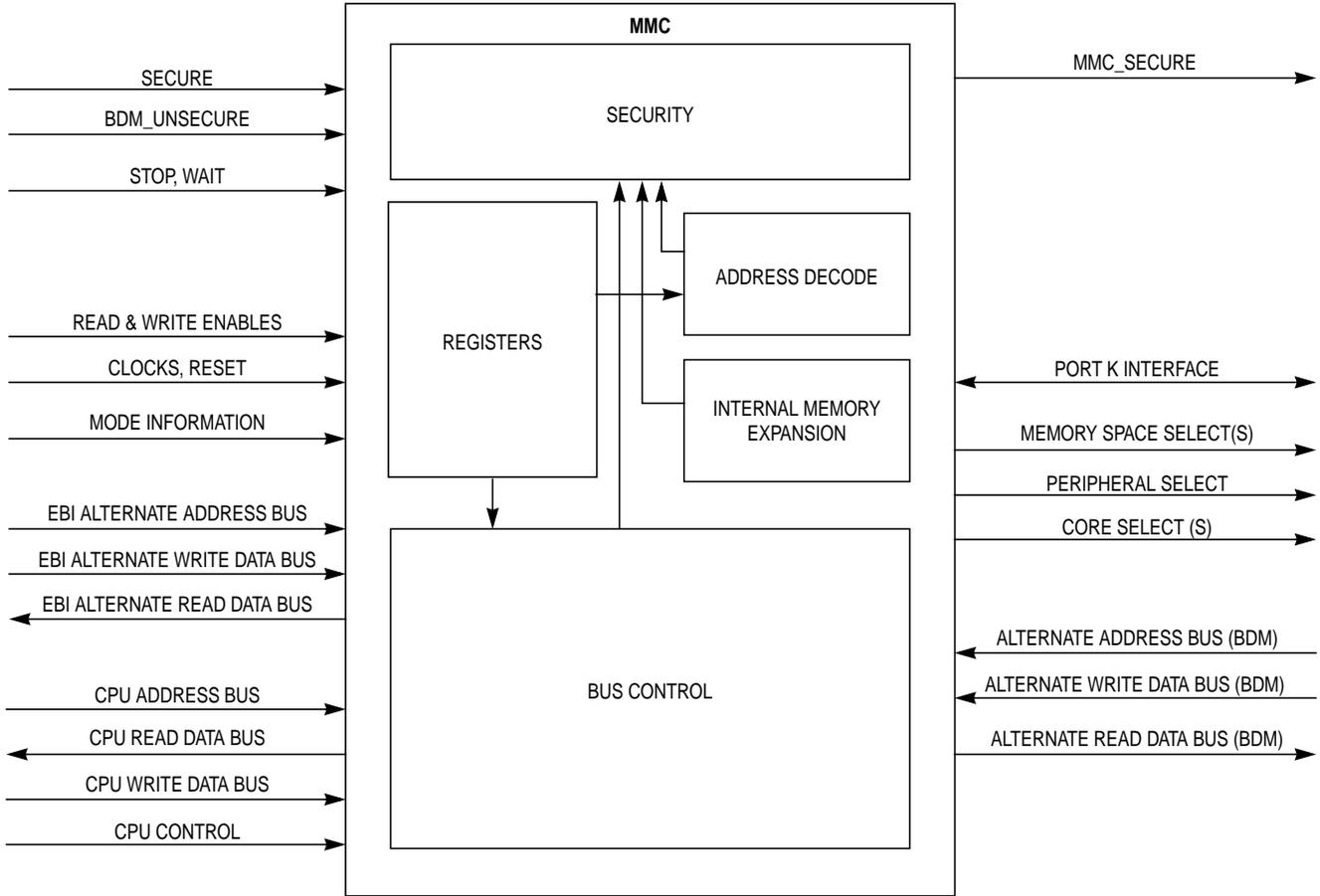


Figure 1-1 Module Mapping Control Block Diagram

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1.1 Overview

The MMC is the submodule which controls memory map assignment and selection of internal resources and external space. Internal buses between the core and memories and between the core and peripherals is controlled in this module. The memory expansion is generated in this module.

1.2 Features

- Registers for mapping of address space for on-chip RAM, EEPROM, and FLASH (or ROM) memory blocks and associated registers
- Memory mapping control and selection based upon address decode and system operating mode
- Core address bus control
- Core data bus control and multiplexing
- Core security state decoding
- Emulation chip select signal generation ($\overline{\text{ECS}}$)
- External chip select signal generation ($\overline{\text{XCS}}$)
- Internal memory expansion
- External stretch and ROM mapping control functions via the MISC register
- Reserved registers for test purposes
- Configurable system memory options defined at integration of Core into the System-on-a-Chip (SOC).

1.3 Modes of Operation

Some of the registers operate differently depending on the mode of operation (i.e., normal expanded wide, special single chip, etc.). This is best understood from the register descriptions.

Section 2 External Signal Description

All interfacing with the MMC sub-block is done within the Core, it has no external signals.

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Section 3 Memory Map/Register Definition

A summary of the registers associated with the MMC sub-block is shown in [Figure 3-1](#). Detailed descriptions of the registers and bits are given in the subsections that follow.

Address	Name		Bit 7	6	5	4	3	2	1	Bit 0
\$0010	INITRM	Read	RAM15	RAM14	RAM13	RAM12	RAM11	0	0	RAMHAL
		Write								
\$0011	INITRG	Read	0	REG14	REG13	REG12	REG11	0	0	0
		Write								
\$0012	INITEE	Read	EE15	EE14	EE13	EE12	EE11	0	0	EEON
		Write								
\$0013	MISC	Read	0	0	0	0	EXSTR1	EXSTR0	ROMHM	ROMON
		Write								
\$0014	MTSTO	Read	BIT 7	6	5	4	3	2	1	BIT 0
		Write								
\$0017	MTST1	Read	BIT 7	6	5	4	3	2	1	BIT 0
		Write								
\$001C	MEMSIZE0	Read	REG_SW0	0	EEP_SW1	EEP_SW0	0	RAM_SW2	RAM_SW1	RAM_SW0
		Write								
\$001D	MEMSIZE1	Read	ROM_SW1	ROM_SW0	0	0	0	0	PAG_SW1	PAG_SW0
		Write								
\$0030	PPAGE	Read	0	0	PIX5	PIX4	PIX3	PIX2	PIX1	PIX0
		Write								
\$0031	Reserved	Read	0	0	0	0	0	0	0	0
		Write								

 = Unimplemented

Figure 3-1 Module Mapping Control Register Summary

3.1 Register Descriptions

3.1.1 Initialization of Internal RAM Position Register (INITRM)

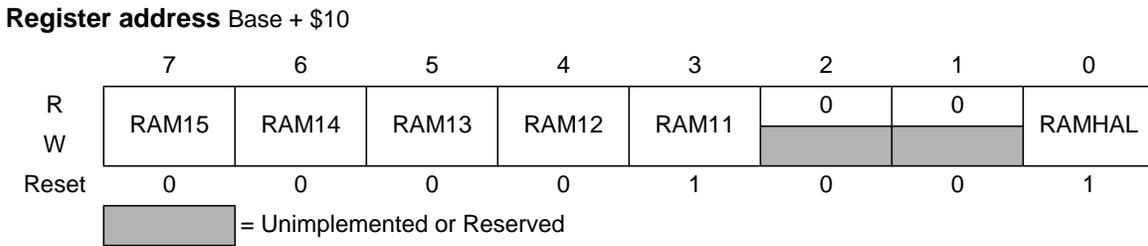


Figure 3-2 Initialization of Internal RAM Position Register (INITRM)

Read: Anytime

Write: Once in Normal and Emulation Modes, anytime in Special Modes

NOTE: Writes to this register take one cycle to go into effect.

This register initializes the position of the internal RAM within the on-chip system memory map.

RAM15–RAM11 — Internal RAM Map Position

These bits determine the upper five bits of the base address for the system’s internal RAM array.

RAMHAL — RAM High-Align

RAMHAL specifies the alignment of the internal RAM array.

0 = Aligns the RAM to the lowest address (\$0000) of the mappable space

1 = Aligns the RAM to the higher address (\$FFFF) of the mappable space

3.1.2 Initialization of Internal Registers Position Register (INITRG)

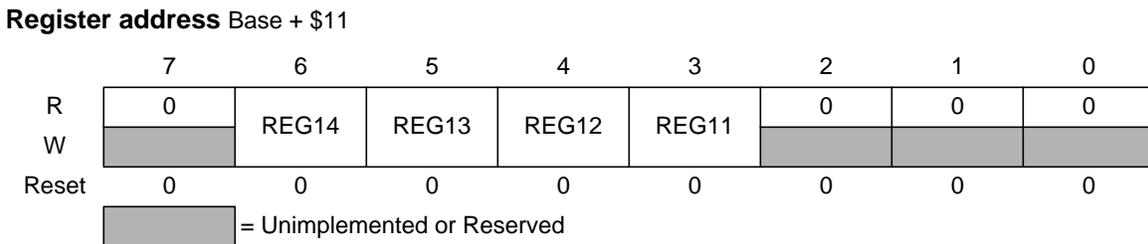


Figure 3-3 Initialization of Internal Registers Position Register (INITRG)

Read: Anytime

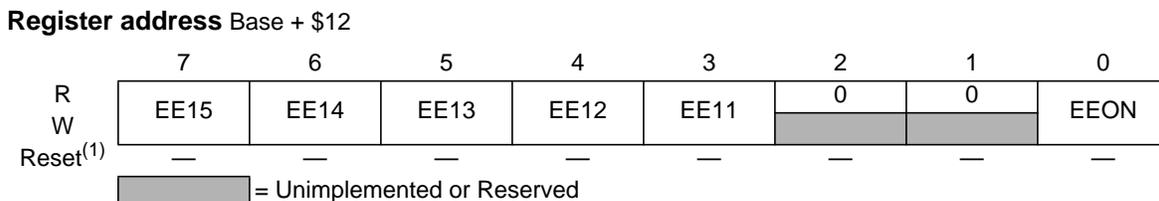
Write: Once in Normal and Emulation modes and anytime in Special modes

This register initializes the position of the internal registers within the on-chip system memory map. The registers occupy either a 1K byte or 2K byte space and can be mapped to any 2K byte space within the first 32K bytes of the system's address space.

REG14–REG11 — Internal Register Map Position

These four bits in combination with the leading zero supplied by bit 7 of INITRG determine the upper five bits of the base address for the system's internal registers (i.e., the minimum base address is \$0000 and the maximum is \$7FFF).

3.1.3 Initialization of Internal EEPROM Position Register (INITEE)



NOTES:

1. The reset state of this register is controlled at chip integration. Please refer to the specific device User's Guide to determine the actual reset state of this register.

Figure 3-4 Initialization of Internal EEPROM Position Register (INITEE)

Read: Anytime

Write: The EEON bit can be written to any time on all devices. Bits E11–E15 are "Write anytime in all modes" on most devices. On some devices, bits E11–E15 are "Write once in Normal and Emulation modes and write anytime in Special modes". See device User's Guide to determine the actual write access rights.

NOTE: *Writes to this register take one cycle to go into effect.*

This register initializes the position of the internal EEPROM within the on-chip system memory map.

EE15–EE11 — Internal EEPROM Map Position

These bits determine the upper five bits of the base address for the system's internal EEPROM array.

EEON — Enable EEPROM

This bit is used to enable the EEPROM memory in the memory map.

- 1 = Enables the EEPROM in the memory map at the address selected by EE15–EE11.
- 0 = Disables the EEPROM from the memory map.

3.1.4 Miscellaneous System Control Register (MISC)

Register address Base + \$13

	7	6	5	4	3	2	1	0
R	0	0	0	0	EXSTR1	EXSTR0	ROMHM	ROMON
W								
Reset: Expanded or Emulation	0	0	0	0	1	1	0	— ⁽¹⁾
Reset: Peripheral or Single Chip	0	0	0	0	1	1	0	1
Reset: Special Test	0	0	0	0	1	1	0	0

= Unimplemented or Reserved

NOTES:

- The reset state of this bit is determined at the chip integration level.

Figure 3-5 Miscellaneous System Control Register (MISC)

Read: Anytime

Write: As stated in each bit description

NOTE: Writes to this register take one cycle to go into effect

This register initializes miscellaneous control functions.

EXSTR1 and EXSTR0 — External Access Stretch Bits 1 and 0

Write: Once in Normal and Emulation modes and anytime in Special modes

This two bit field determines the amount of clock stretch on accesses to the external address space as shown in [Table 3-1](#). In single chip and peripheral modes these bits have no meaning or effect.

Table 3-1 External Stretch Bit Definition

Stretch Bit EXSTR1	Stretch Bit EXSTR0	Number of E Clocks Stretched
0	0	0
0	1	1
1	0	2
1	1	3

ROMHM — FLASH EEPROM or ROM Only in Second Half of Memory Map

Write: Once in Normal and Emulation modes and anytime in Special modes

- 1 = Disables direct access to the FLASH EEPROM or ROM in the lower half of the memory map. These physical locations of the FLASH EEPROM or ROM can still be accessed through the Program Page window.
- 0 = The fixed page(s) of FLASH EEPROM or ROM in the lower half of the memory map can be accessed.

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ROMON — Enable FLASH EEPROM or ROM

Write: Once in Normal and Emulation modes and anytime in Special modes

This bit is used to enable the FLASH EEPROM or ROM memory in the memory map.

1 = Enables the FLASH EEPROM or ROM in the memory map.

0 = Disables the FLASH EEPROM or ROM from the memory map.

3.1.5 Reserved Test Register Zero (MTST0)

Register address Base + \$14

	7	6	5	4	3	2	1	0
R	0	0	0	0	0	0	0	0
W								
Reset	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 3-6 Reserved Test Register Zero (MTST0)

Read: Anytime

Write: No effect — this register location is used for internal test purposes.

3.1.6 Reserved Test Register One (MTST1)

Register address Base + \$17

	7	6	5	4	3	2	1	0
R	0	0	0	0	0	0	0	0
W								
Reset	0	0	0	1	0	0	0	0

= Unimplemented or Reserved

Figure 3-7 Reserved Test Register One (MTST1)

Read: Anytime

Write: No effect — this register location is used for internal test purposes.

3.1.7 Memory Size Register Zero (MEMSIZ0)



Figure 3-8 Memory Size Register Zero

Read: Anytime

Write: Writes have no effect

Reset: Defined at chip integration, see chip level documentation.

The MEMSIZ0 register reflects the state of the register, EEPROM and RAM memory space configuration switches at the Core boundary which are configured at system integration. This register allows read visibility to the state of these switches.

REG_SW0 — Allocated System Register Space

1 = Allocated system register space size is 2K byte

0 = Allocated system register space size is 1K byte

EEP_SW1:EEP_SW0 — Allocated System EEPROM Memory Space

The allocated system EEPROM memory space size is as given in [Table 3-2](#).

Table 3-2 Allocated EEPROM Memory Space

EEP_SW1:EEP_SW0	Allocated EEPROM Space
00	0K byte
01	2K bytes
10	4K bytes
11	8K bytes

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RAM_SW2:RAM_SW0 — Allocated System RAM Memory Space

The allocated system RAM memory space size is as given in [Table 3-3](#).

Table 3-3 Allocated RAM Memory Space

RAM_SW2:RAM_SW0	Allocated RAM Space	RAM Mappable Region	INITRM Bits Used	RAM Reset Base Address ⁽¹⁾
000	2K bytes	2K bytes	RAM15–RAM11	\$0800
001	4K bytes	4K bytes	RAM15–RAM12	\$0000
010	6K bytes	8K bytes ⁽²⁾	RAM15–RAM13	\$0800
011	8K bytes	8K bytes	RAM15–RAM13	\$0000
100	10K bytes	16K bytes ²	RAM15–RAM14	\$1800
101	12K bytes	16K bytes ²	RAM15–RAM14	\$1000
110	14K bytes	16K bytes ²	RAM15–RAM14	\$0800
111	16K bytes	16K bytes	RAM15–RAM14	\$0000

NOTES:

1. The RAM Reset BASE Address is based on the reset value of the INITRM register, \$09.
2. Alignment of the Allocated RAM space within the RAM mappable region is dependent on the value of RAMHAL.

NOTE: *As stated, the bits in this register provide read visibility to the system physical memory space allocations defined at system integration. The actual array size for any given type of memory block may differ from the allocated size. Please refer to the chip-level documentation for actual sizes.*

3.1.8 Memory Size Register One (MEMSIZ1)

Register address Base + \$1D



Figure 3-9 Memory Size Register One

Read: Anytime

Write: Writes have no effect

Reset: Defined at chip integration, see chip level documentation.

The MEMSIZ1 register reflects the state of the FLASH or ROM physical memory space and paging switches at the Core boundary which are configured at system integration. This register allows read visibility to the state of these switches.

ROM_SW1:ROM_SW0 — Allocated System FLASH or ROM Physical Memory Space

The allocated system FLASH or ROM physical memory space is as given in [Table 3-4](#).

Table 3-4 Allocated FLASH/ROM Physical Memory Space

ROM_SW1:ROM_SW0	Allocated FLASH or ROM Space
00	0K byte
01	16K bytes
10	48K bytes ⁽¹⁾
11	64K bytes ⁽¹⁾

NOTES:

- The ROMHM software bit in the MISC register determines the accessibility of the FLASH/ROM memory space. Please refer to [3.1.8 Memory Size Register One \(MEMSIZ1\)](#) for a detailed functional description of the ROMHM bit.

PAG_SW1:PAG_SW0 — Allocated Off-Chip FLASH or ROM Memory Space

The allocated off-chip FLASH or ROM memory space size is as given in [Table 3-5](#).

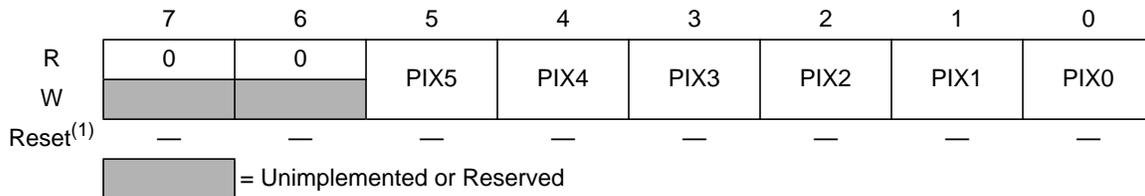
Table 3-5 Allocated Off-Chip Memory Options

PAG_SW1:PAG_SW0	Off-Chip Space	On-Chip Space
00	876K bytes	128K bytes
01	768K bytes	256K bytes
10	512K bytes	512K bytes
11	0K byte	1M byte

NOTE: *As stated, the bits in this register provide read visibility to the system memory space and on-chip/off-chip partitioning allocations defined at system integration. The actual array size for any given type of memory block may differ from the allocated size. Please refer to the chip-level documentation for actual sizes.*

3.1.9 Program Page Index Register (PPAGE)

Register address Base + \$30



NOTES:

- The reset state of this register is controlled at chip integration. Please refer to the specific device User's Guide to determine the actual reset state of this register.

Figure 3-10 Program Page Index Register (PPAGE)

Read: Anytime

Write: Determined at chip integration. Generally it's: "Write anytime in all modes"; on some devices it will be: "Write only in Special modes". Check specific device documentation to determine which applies.

Reset: Defined at chip integration as either \$00 (paired with write in any mode) or \$3C (paired with write only in special modes), see chip level documentation.

The HCS12 Core architecture limits the physical address space available to 64K bytes. The Program Page Index Register allows for integrating up to 1M byte of FLASH or ROM into the system by using the six page index bits to page 16K byte blocks into the Program Page Window located from \$8000 to \$BFFF as defined in [Table 3-6](#). CALL and RTC instructions have special access to read and write this register without using the address bus.

NOTE: Normal writes to this register take one cycle to go into effect. Writes to this register using the special access of the CALL and RTC instructions will be complete before the end of the associated instruction.

PIX5–PIX0 — Program Page Index Bits 5–0

These page index bits are used to select which of the 64 FLASH or ROM array pages is to be accessed in the Program Page Window as shown in [Table 3-6](#).

Table 3-6 Program Page Index Register Bits

PIX5	PIX4	PIX3	PIX2	PIX1	PIX0	Program Space Selected
0	0	0	0	0	0	16K page 0
0	0	0	0	0	1	16K page 1
0	0	0	0	1	0	16K page 2
0	0	0	0	1	1	16K page 3
.
.
.
.
1	1	1	1	0	0	16K page 60
1	1	1	1	0	1	16K page 61
1	1	1	1	1	0	16K page 62
1	1	1	1	1	1	16K page 63

Section 4 Functional Description

The MMC sub-block performs four basic functions of the Core operation: bus control, address decoding and select signal generation, memory expansion, and security decoding for the system. Each aspect is described in the following subsections.

4.1 Bus Control

The MMC controls the address bus and data buses that interface the Core with the rest of the system. This includes the multiplexing of the input data buses to the Core onto the main CPU read data bus and control of data flow from the CPU to the output address and data buses of the Core. In addition, the MMC handles all CPU read data bus swapping operations.

4.2 Address Decoding

As data flows on the Core address bus, the MMC decodes the address information, determines whether the internal Core register or firmware space, the peripheral space or a memory register or array space is being addressed and generates the correct select signal. This decoding operation also interprets the mode of operation of the system and the state of the mapping control registers in order to generate the proper select. The MMC also generates two external chip select signals, Emulation Chip Select (\overline{ECS}) and External Chip Select (\overline{XCS}).

4.2.1 Select Priority and Mode Considerations

Although internal resources such as control registers and on-chip memory have default addresses, each can be relocated by changing the default values in control registers. Normally, I/O addresses, control registers, vector spaces, expansion windows, and on-chip memory are mapped so that their address ranges do not overlap. The MMC will make only one select signal active at any given time. This activation is based upon the priority outlined in [Table 4-1](#). If two or more blocks share the same address space, only the select signal for the block with the highest priority will become active. An example of this is if the registers and the RAM are mapped to the same space, the registers will have priority over the RAM and the portion of RAM mapped in this shared space will not be accessible. The expansion windows have the lowest priority. This means that registers, vectors, and on-chip memory are always visible to a program regardless of the values in the page select registers.

Table 4-1 Select Signal Priority

Priority	Address Space
Highest	BDM (internal to Core) firmware or register space
...	Internal register space
...	RAM memory block
...	EEPROM memory block
...	On-chip FLASH or ROM
Lowest	Remaining external space

In expanded modes, all address space not used by internal resources is by default external memory space. The data registers and data direction registers for Ports A and B are removed from the on-chip memory map and become external accesses. If the EMK bit in the MODE register (see MEBI Block Guide) is set, the data and data direction registers for Port E are also removed from the on-chip memory map and become external accesses.

In Special Peripheral mode, the first 16 registers associated with bus expansion are removed from the on-chip memory map (PORTA, PORTB, DDRA, DDRB, PORTE, DDRE, PEAR, MODE, PUCR, RDRIV, and the EBI reserved registers).

In emulation modes, if the EMK bit in the MODE register (see MEBI Block Guide) is set, the data and data direction registers for Port K are removed from the on-chip memory map and become external accesses.

4.2.2 Emulation Chip Select Signal

When the EMK bit in the MODE register (see MEBI Block Guide) is set, Port K bit 7 is used as an active-low emulation chip select signal, $\overline{\text{ECS}}$. This signal is active when the system is in Emulation mode, the EMK bit is set and the FLASH or ROM space is being addressed subject to the conditions outlined in **4.3.2 Extended Address (XAB19:14) and ECS Signal Functionality**. When the EMK bit is clear, this pin is used for general purpose I/O.

4.2.3 External Chip Select Signal

When the EMK bit in the MODE register (see MEBI Block Guide) is set, Port K bit 6 is used as an active-low external chip select signal, $\overline{\text{XCS}}$. This signal is active only when the $\overline{\text{ECS}}$ signal described above is not active and when the system is addressing the external address space. Accesses to unimplemented locations within the register space or to locations that are removed from the map (i.e., Ports A and B in Expanded modes) will not cause this signal to become active. When the EMK bit is clear, this pin is used for general purpose I/O.

4.3 Memory Expansion

The HCS12 Core architecture limits the physical address space available to 64K bytes. The Program Page Index Register allows for integrating up to 1M byte of FLASH or ROM into the system by using the six page index bits to page 16K byte blocks into the Program Page Window located from \$8000 to \$BFFF in the physical memory space. The paged memory space can consist of solely on-chip memory or a combination of on-chip and off-chip memory. This partitioning is configured at system integration through the use of the paging configuration switches (*pag_sw1:pag_sw0*) at the Core boundary. The options available to the integrator are as given in **Table 4-2** (this table matches **Table 3-5** but is repeated here for easy reference).

Table 4-2 Allocated Off-Chip Memory Options

pag_sw1:pag_sw0	Off-Chip Space	On-Chip Space
00	876K byte2	128K byte2
01	768K byte2	256K byte2
10	512K byte2	512K byte2
11	0K byte	1M byte

Based upon the system configuration, the Program Page Window will consider its access to be either internal or external as defined in [Table 4-3](#).

Table 4-3 External/Internal Page Window Access

pag_sw1:pag_sw0	Partitioning	PIX5:0 Value	Page Window Access
00	876K off-Chip, 128K on-Chip	\$00–\$37	External
		\$38–\$3F	Internal
01	768K off-chip, 256K on-chip	\$00–\$2F	External
		\$30–\$3F	Internal
10	512K off-chip, 512K on-chip	\$00–\$1F	External
		\$20–\$3F	Internal
11	0K off-chip, 1M on-chip	N/A	External
		\$00–\$3F	Internal

NOTE: *The partitioning as defined in [Table 4-3](#) applies only to the allocated memory space and the actual on-chip memory sizes implemented in the system may differ. Please refer to the chip-level documentation for actual sizes.*

The PPAGE register holds the page select value for the Program Page Window. The value of the PPAGE register can be manipulated by normal read and write (some devices don't allow writes in some modes) instructions as well as the CALL and RTC instructions.

Control registers, vector spaces, and a portion of on-chip memory are located in unpagged portions of the 64K byte physical address space. The stack and I/O addresses should also be in unpagged memory to make them accessible from any page.

The starting address of a service routine must be located in unpagged memory because the 16-bit exception vectors cannot point to addresses in pagged memory. However, a service routine can call other routines that are in pagged memory. The upper 16K byte block of memory space (\$C000–\$FFFF) is unpagged. It is recommended that all reset and interrupt vectors point to locations in this area.

4.3.1 CALL and Return from Call Instructions

CALL and RTC are uninterruptible instructions that automate page switching in the program expansion window. CALL is similar to a JSR instruction, but the subroutine that is called can be located anywhere in the normal 64K byte address space or on any page of program expansion memory. CALL calculates and stacks a return address, stacks the current PPAGE value, and writes a new instruction-supplied value to PPAGE. The PPAGE value controls which of the 64 possible pages is visible through the 16K byte expansion window in the 64K byte memory map. Execution then begins at the address of the called subroutine.

During the execution of a CALL instruction, the CPU:

- Writes the old PPAGE value into an internal temporary register and writes the new instruction-supplied PPAGE value into the PPAGE register.
- Calculates the address of the next instruction after the CALL instruction (the return address), and pushes this 16-bit value onto the stack.
- Pushes the old PPAGE value onto the stack.
- Calculates the effective address of the subroutine, refills the queue, and begins execution at the new address on the selected page of the expansion window.

This sequence is uninterruptible; there is no need to inhibit interrupts during CALL execution. A CALL can be performed from any address in memory to any other address.

The PPAGE value supplied by the instruction is part of the effective address. For all addressing mode variations except indexed-indirect modes, the new page value is provided by an immediate operand in the instruction. In indexed-indirect variations of CALL, a pointer specifies memory locations where the new page value and the address of the called subroutine are stored. Using indirect addressing for both the new page value and the address within the page allows values calculated at run time rather than immediate values that must be known at the time of assembly.

The RTC instruction terminates subroutines invoked by a CALL instruction. RTC unstacks the PPAGE value and the return address and refills the queue. Execution resumes with the next instruction after the CALL.

During the execution of an RTC instruction, the CPU:

- Pulls the old PPAGE value from the stack
- Pulls the 16-bit return address from the stack and loads it into the PC
- Writes the old PPAGE value into the PPAGE register
- Refills the queue and resumes execution at the return address

This sequence is uninterruptible; an RTC can be executed from anywhere in memory, even from a different page of extended memory in the expansion window.

The CALL and RTC instructions behave like JSR and RTS, except they use more execution cycles. Therefore, routinely substituting CALL/RTC for JSR/RTS is not recommended. JSR and RTS can be used to access subroutines that are on the same page in expanded memory. However, a subroutine in expanded memory that can be called from other pages must be terminated with an RTC. And the RTC unstacks a

PPAGE value. So any access to the subroutine, even from the same page, must use a CALL instruction so that the correct PPAGE value is in the stack.

4.3.2 Extended Address (XAB19:14) and $\overline{\text{ECS}}$ Signal Functionality

If the EMK bit in the MODE register is set (see MEBI Block Guide) the PIX5:0 values will be output on XAB19:14 respectively (Port K bits 5:0) when the system is addressing within the physical Program Page Window address space (\$8000–\$BFFF) and is in an expanded mode. When addressing anywhere else within the physical address space (outside of the paging space), the XAB19:14 signals will be assigned a constant value based upon the physical address space selected. In addition, the active-low emulation chip select signal, $\overline{\text{ECS}}$, will likewise function based upon the assigned memory allocation. In the cases of 48K byte and 64K byte allocated physical FLASH/ROM space, the operation of the $\overline{\text{ECS}}$ signal will additionally depend upon the state of the ROMHM bit (see 3.1.4 Miscellaneous System Control Register (MISC)) in the MISC register. Table 4-4, Table 4-5, Table 4-6, and Table 4-7 summarize the functionality of these signals based upon the allocated memory configuration. Again, this signal information is only available externally when the EMK bit is set and the system is in an expanded mode.

Table 4-4 0K Byte Physical FLASH/ROM Allocated

Address Space	Page Window Access	ROMHM	$\overline{\text{ECS}}$	XAB19:14
\$0000–\$3FFF	N/A	N/A	1	\$3D
\$4000–\$7FFF	N/A	N/A	1	\$3E
\$8000–\$BFFF	N/A	N/A	0	PIX5:0
\$C000–\$FFFF	N/A	N/A	0	\$3F

Table 4-5 16K Byte Physical FLASH/ROM Allocated

Address Space	Page Window Access	ROMHM	$\overline{\text{ECS}}$	XAB19:14
\$0000–\$3FFF	N/A	N/A	1	\$3D
\$4000–\$7FFF	N/A	N/A	1	\$3E
\$8000–\$BFFF	N/A	N/A	1	PIX5:0
\$C000–\$FFFF	N/A	N/A	0	\$3F

Table 4-6 48K Byte Physical FLASH/ROM Allocated

Address Space	Page Window Access	ROMHM	$\overline{\text{ECS}}$	XAB19:14
\$0000–\$3FFF	N/A	N/A	1	\$3D
\$4000–\$7FFF	N/A	0	0	\$3E
	N/A	1	1	
\$8000–\$BFFF	External	N/A	1	PIX5:0
	Internal	N/A	0	
\$C000–\$FFFF	N/A	N/A	0	\$3F

Table 4-7 64K Byte Physical FLASH/ROM Allocated

Address Space	Page Window Access	ROMHM	$\overline{\text{ECS}}$	XAB19:14
\$0000-\$3FFF	N/A	0	0	\$3D
	N/A	1	1	
\$4000-\$7FFF	N/A	0	0	\$3E
	N/A	1	1	
\$8000-\$BFFF	External	N/A	1	PIX5:0
	Internal	N/A	0	
\$C000-\$FFFF	N/A	N/A	0	\$3F

A graphical example of a memory paging for a system configured as 1M byte on-chip FLASH/ROM with 64K allocated physical space is given in [Figure 4-1](#).

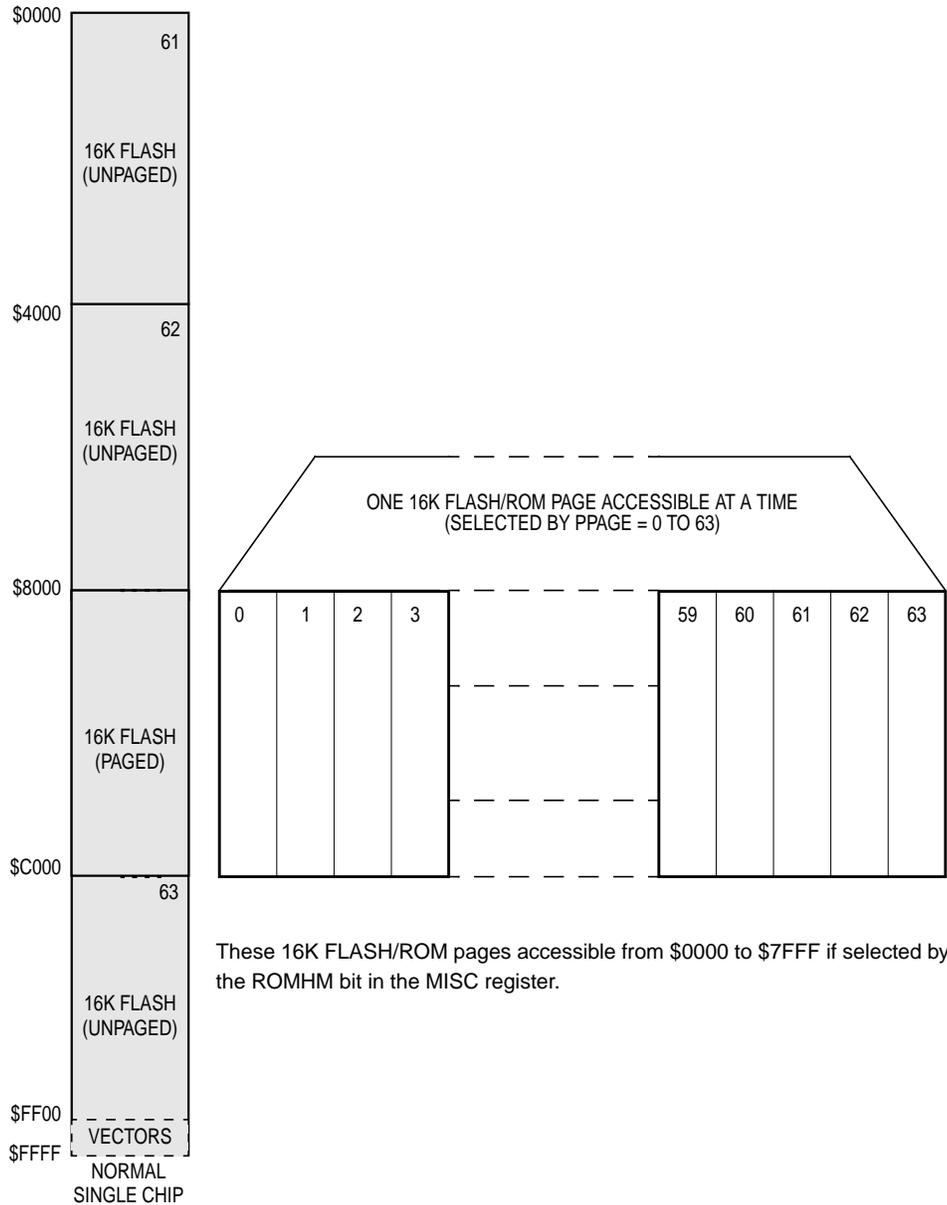


Figure 4-1 Memory Paging Example: 1M Byte On-Chip FLASH/ROM, 64K Allocation

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